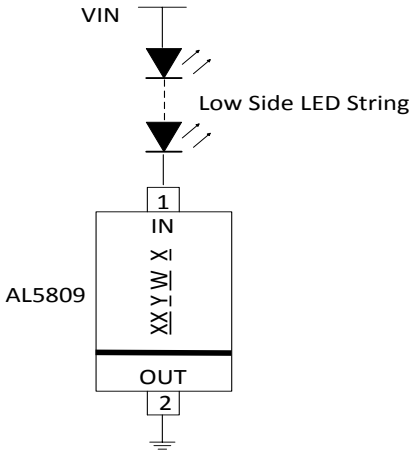
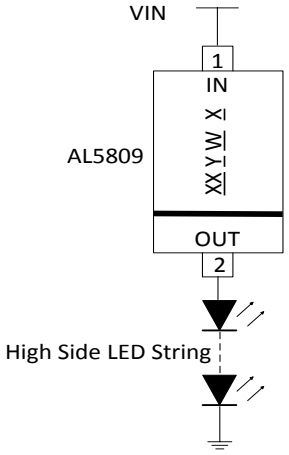
Typical Applications Circuit

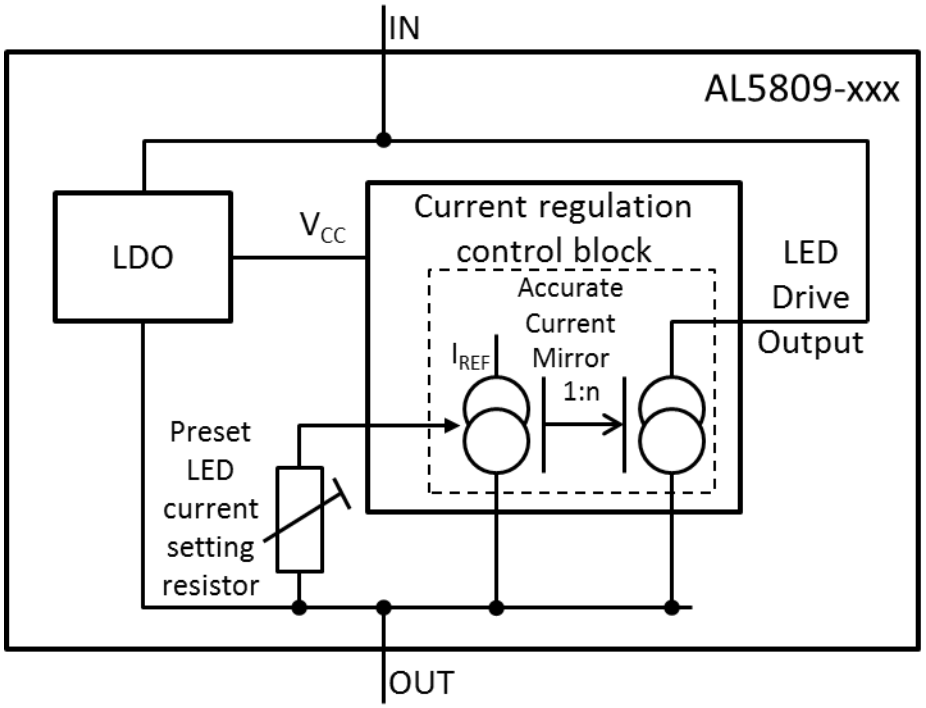




Pin Descriptions

Pin Name	Pin Number (PowerDI123)	Function
In	1	LED Current Input Terminal. For low side LED string application, connect the LED cathode terminal to the “In” terminal. For high side LED string application, connect the LED anode terminal to the “Out” terminal.
Out	2	LED Current Output Terminal. For low side LED string application, connect the LED anode terminal to the “Out” terminal. For high side LED string application, connect the LED cathode terminal to the “Out” terminal.

Functional Block Diagram



Absolute Maximum Ratings

Symbol	Parameters	Ratings	Unit
V_{InOut}	"In" Voltage Relative to "Out" Pin	-0.3 to +80	V
I_{InOut}	LED Current from "In" to "Out"	180	mA
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
T_J	Operating Junction Temperature	-40 to +175	°C
T_{ST}	Storage Temperature	-55 to +150	°C

Caution: Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.
Semiconductor devices are ESD sensitive and may be damaged by exposure to ESD events. Suitable ESD precautions should be taken when handling and transporting these devices.

Package Thermal Data

Package	θ_{JC} Thermal Resistance Junction-to-Case	θ_{JA} Thermal Resistance Junction-to-Ambient	P_{DIS} T_A = +25°C, T_J = +125°C
PowerDI123	27.15°C/W	148.61°C/W (Note 4)	0.68W
PowerDI123	17.81°C/W	81.39°C/W (Note 5)	1.24W
SOD-123	69.56°C/W	278.42°C/W (Note 6)	0.36W

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{InOut}	"In" Voltage Range Relative to "Out" Pin	2.5	60	V
I_{InOut}	LED Current (Note 7)	15	150	mA
T_A	Operating Ambient Temperature Range (Note 8)	-40	+125	°C

Electrical Characteristics (V_{InOut} = 3.5V) (Note 9)

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{InOut}	In-Out Supply Voltage	-	T_A = -40°C to +125°C	2.5	-	60	V
I_{InOut}	I_{INOut} Current Accuracy (±5% for over temperature)	AL5809-15S1-7 AL5809-15P1-7	T_A = -40°C to +125°C	14.25	15	15.75	mA
		AL5809-20S1-7 AL5809-20P1-7	T_A = -40°C to +125°C	19	20	21	
		AL5809-25S1-7 AL5809-25P1-7	T_A = -40°C to +125°C	23.75	25	26.25	
		AL5809-30S1-7 AL5809-30P1-7	T_A = -40°C to +125°C	28.5	30	31.5	
		AL5809-40S1-7 AL5809-40P1-7	T_A = -40°C to +125°C	38	40	42	
		AL5809-50S1-7 AL5809-50P1-7	T_A = -40°C to +125°C	47.5	50	52.5	
		AL5809-60P1-7	T_A = -40°C to +125°C	57	60	63	
		AL5809-90P1-7	T_A = -40°C to +125°C	85.5	90	94.5	
		AL5809-100P1-7	T_A = -40°C to +125°C	95	100	105	
		AL5809-120P1-7	T_A = -40°C to +125°C	114	120	126	
		AL5809-150P1-7	T_A = -40°C to +125°C	142.5	150	157.5	
I_{LINE}	I_{InOut} Current Line Regulation	V_{InOut} = 2.5V to 60V (Note 10)	T_A = +25°C	-	1	-	%
V_{MIN}	Minimum Power Up Voltage	Increase V_{InOut} (Note 11)	T_A = -40°C to +125°C	-	1.5	-	V
t_{ON_MIN}	Minimum On pulse width	(Note 12, 13)	-	500	-	-	µS
t_{OFF_MIN}	Minimum Off pulse width	(Note 12, 13)	-	500	-	-	µS
T_{SHDN}	Thermal Shutdown	Junction Temperature (Note 14)	-	-	+165	-	°C
T_{HYS}	Thermal Shutdown Hysteresis	-	-	-	+30	-	°C

Notes:
4. Test condition for PowerDI-123: Device mounted on 25.4mm x 25.4mm FR-4 PCB (10mm x 10mm 1oz copper, minimum recommended pad layout on top layer and thermal vias to bottom layer ground plane). For better thermal performance, larger copper pad for heat-sink is needed.
5. When mounted on 50.8mm x 50.8mm GETEK PCB with 25.4mm x 25.4mm copper pads.
6. Test condition for SOD-123: Device mounted on FR-4 PCB with 50.8mm x 50.8mm 2oz copper, minimum recommended pad layout on top layer and thermal vias to bottom layer with maximum area ground plane. For better thermal performance, larger copper pad for heat-sink is needed.
7. The LED operating current is determined by the AL5809 current option index XXX, AL5809-XXXS/P1-7.
8. The Maximum LED current is also limited by ambient temperature and power dissipation such that junction temperature should be kept less than or equal to +125°C.
9. All voltages unless otherwise stated are measured with respect to OUT pin.
10. Measured by the percentage degree of LED current variation when V_{InOut} varies from 2.5V to 60V each current option.
11. Apply the power linearly to the chip until the device starts to turn on.
12. t_{ON_MIN} time includes the delay and the rise time needed for I_{OUT} to reach 90% of its final value. t_{OFF_MIN} time is the time needed for I_{OUT} to drop below 10% of its final value.
13. This parameter only guaranteed by design, not tested in production.
14. Ambient temperature at which OTP is triggered may vary depending on application, PCB layout and material used.

Application Information

Description

The AL5809 is a constant current Linear LED driver and can be placed in series with LEDs as a High Side or a Low Side constant current regulator. The AL5809 offers various current settings from 15mA up to 150mA and different current settings available upon request (contact Diodes local sales office at http://www.diodes.com).

The AL5809 contains a Low-Dropout regulator which provides power to the internal Current regulation control block. A fixed preset LED current setting resistor sets the reference current of the Current regulation block. The LED current setting resistor varies with each variant of the AL5809. An accurate current mirror within the Current regulation control block increases the reference current to the preset LED current of the AL5809.

Simple LED String

The AL5809 can be placed in series with LEDs as a Low Side/High Side constant current regulator. The number of the LEDs can vary from one to as many as can be supported by the input supply voltage. The designer needs to calculate the maximum voltage between In and Out by taking the maximum input voltage minus the voltage across the LED string (Figures 1 & 2).

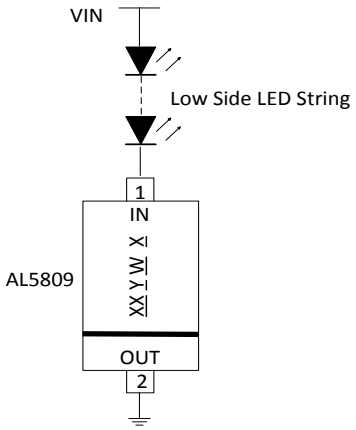


Figure 1 Low Side LED String Tapping

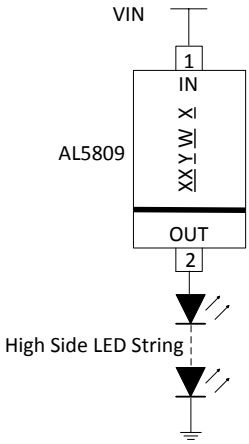
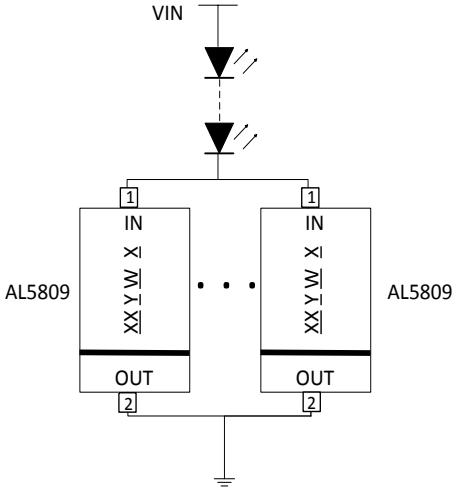


Figure 2 High Side LED String Tapping

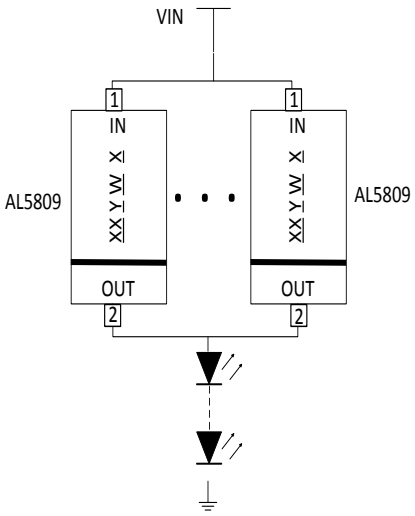
The AL5809 can also be used on the high side of the LEDs, see Figure 2. The minimum system input voltage can be calculated by:

$V_{IN(min)} = V_{LED\_CHAIN} + 2.5V$ Where V_{LED_CHAIN} is the LED chain voltage.

The LED current can be increased by connecting two or more AL5809 in parallel in Figure 3.



(a)Low Side Configuration



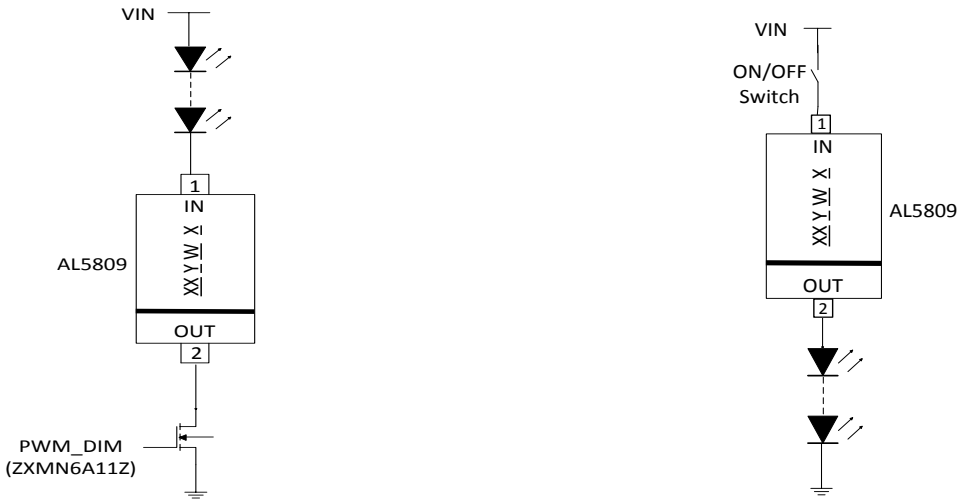
(b) High Side Configuration

Figure 3 Higher LED Current by Parallel Configuration of AL5809

Application Information (continued)

PWM Dimming

The AL5809 can be used to provide LED current dimming driving the Out pin via the MOSFET switch to ground (Figure 4a) applying a PWM signal with a frequency range between 100Hz and 200Hz. The Out pin current is then effectively switched on and off to modulate the output LED current. The dimming effect can be achieved by varying the PWM signal duty cycle.



a) PWM Dimming by External MOSFET **b) PWM Dimming by Power Supply VIN ON/OFF**

Figure 4 PWM Dimming

Recommended PWM Frequency and Dimming Range

PWM Frequency (Hz)	Duty Cycle (%)	
	Min	Max
100	5	95
200	10	90

Test conditions (Figure 4a): PWM frequency 100Hz–200Hz Square wave, 0-4V gate voltage, VIN = 6V, 1 LED, AL5809-30mA

Use the following formula to calculate the Min and Max duty cycle:

Min. Duty cycle (%) = (t_{ON_MIN}) / (time period of the PWM signal)
Max. Duty cycle (%) = 100% - ((t_{OFF_MIN}) / (time period of the PWM signal))

Notes: t_{ON_MIN} = 0.5mS (Min. value), and t_{OFF_MIN} = 0.5mS (Min. value) are listed in the Electrical Characteristics table on page 4.

Application Information (continued)

Dimming Curves

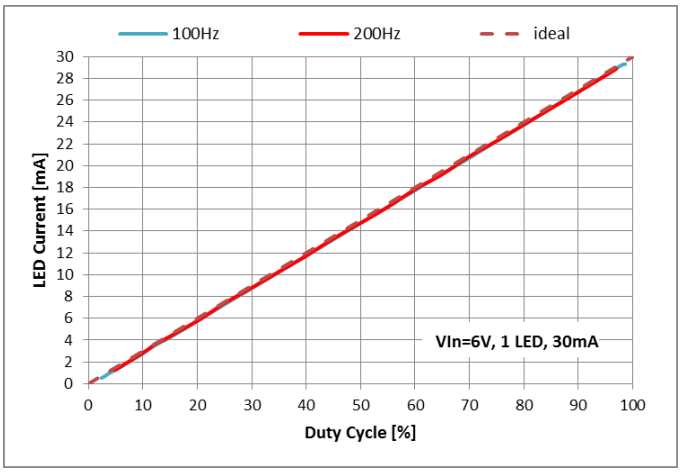


Figure 5 PWM Dimming 30mA vs. Duty Cycle

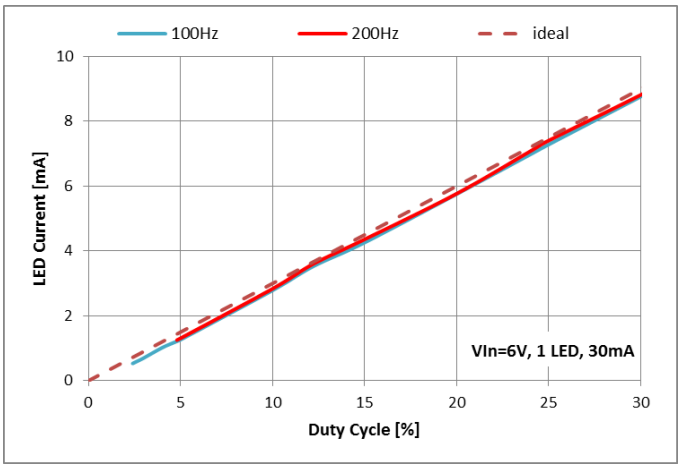


Figure 6 Area Zoom In within Duty Cycle 30% of Figure 5

Recommended Minimum On/Off Pulse Width

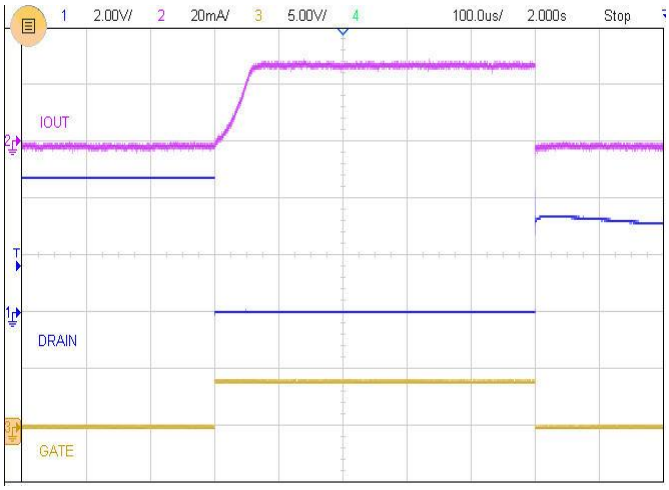


Figure 7 Minimum On Pulse Width (t_{ON_MIN})

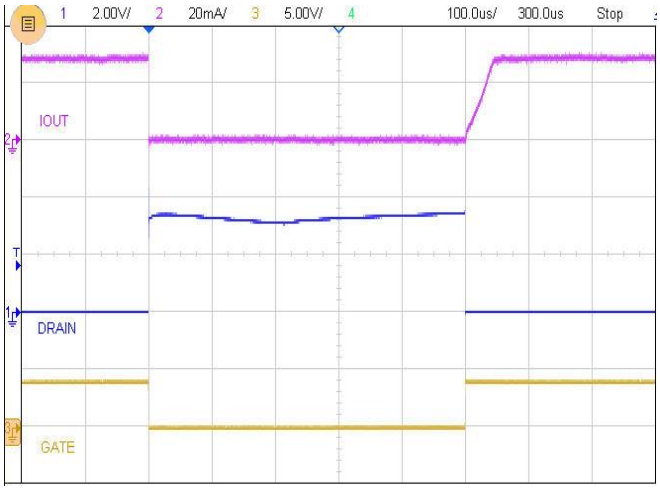


Figure 8 Minimum Off Pulse Width (t_{OFF_MIN})

Application Information (cont.)

Power Dissipation

The maximum ambient temperature range of the AL5809 is determined by its power dissipation and thermal impedance of the PCB onto which it is mounted. Its junction temperature must be kept equal to or less than +125°C.

The power dissipated is determined by the LED current version that has been selected (15, 20, 25 30, 40, 50, 60, 90, 100, 120 or 150mA) and the difference between the input voltage and LED chain voltage.

$V_{INOUT} * I_{LED}$

In a typical 12V system, the input voltage can vary between 11.4V and 12.6V. The recommended minimum V_{INOUT} voltage of 2.5V enables the AL5809 to drive 2 LED in series from the 12V rail (assuming V_{LED} <3.25V).

The AL5809's power dissipation under minimum input voltage conditions will be: $V_{INOUT} * I_{LED} = (11.4\text{-}6.5) * I_{LED}$
So for the 20mA AL5809-20PI under these conditions this equals: $4.9V * 20mA = 98mW$

Under maximum input conditions (12.6V) the AL5809's power dissipation will be: $V_{INOUT} * I_{LED} = (12.6\text{-}6.5) * I_{LED}$
So for the 20mA AL5809-20QPI this equals: $6.1V * 20mA = 122mW$

So there is a large difference in power dissipation of the Linear LED driver between minimum and maximum battery voltages. And care must be taken to calculate expected power dissipations and then determine the suitable PCB material and layout. See Figures 9, 10 and 11 for graphs showing power dissipation and maximum V_{INOUT}, for different currents and PCB material. Maximizing the area and mass of the ground plane and additional vias between the pad of the OUT pin will improve the thermal impedance (θ_{JA}) of the AL5809.

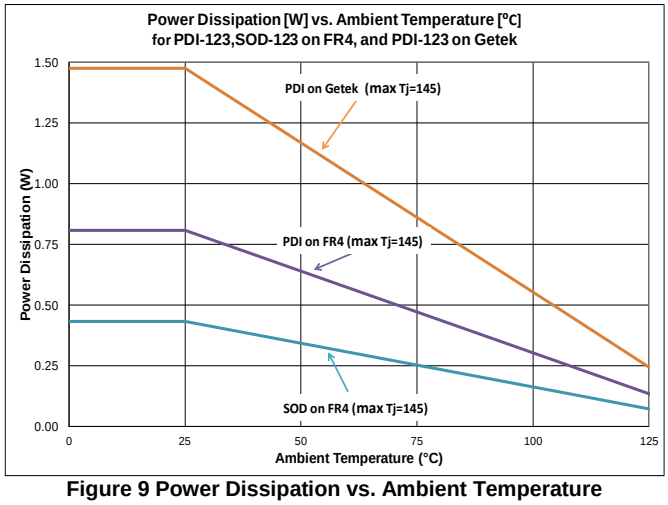


Figure 9 Power Dissipation vs. Ambient Temperature @T_J = +145°C

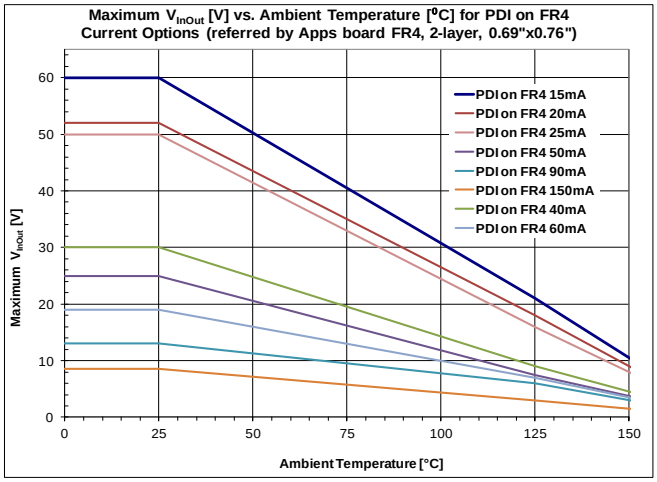


Figure 10 Maximum V_{InOut} vs. Temperature

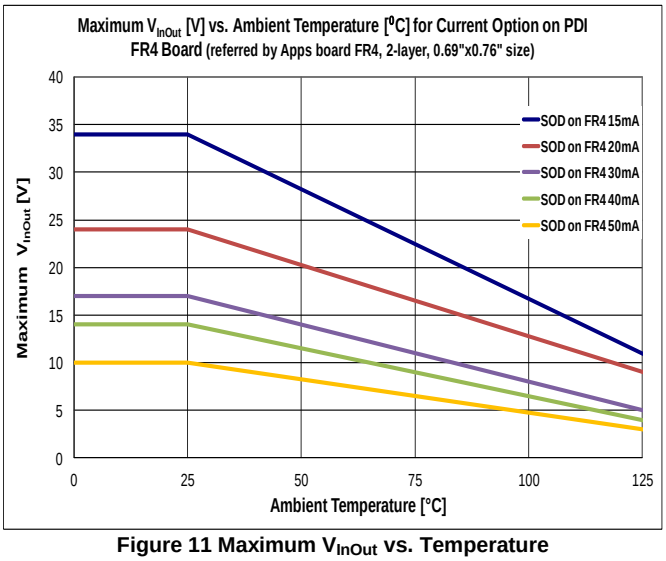


Figure 11 Maximum V_{InOut} vs. Temperature

Application Information (cont.)

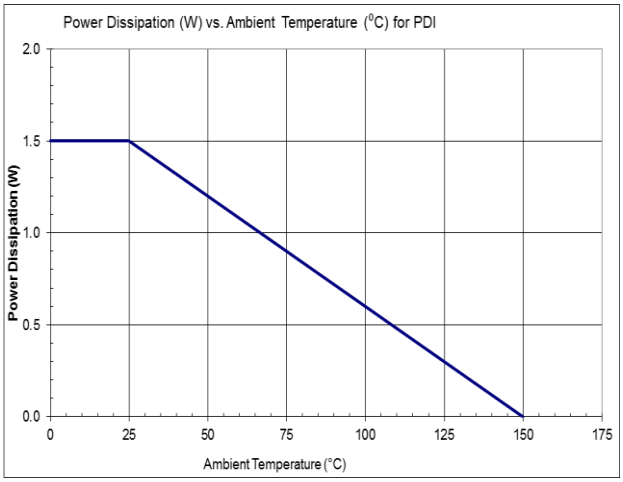


Figure 12 Power Dissipation vs. Ambient Temperature

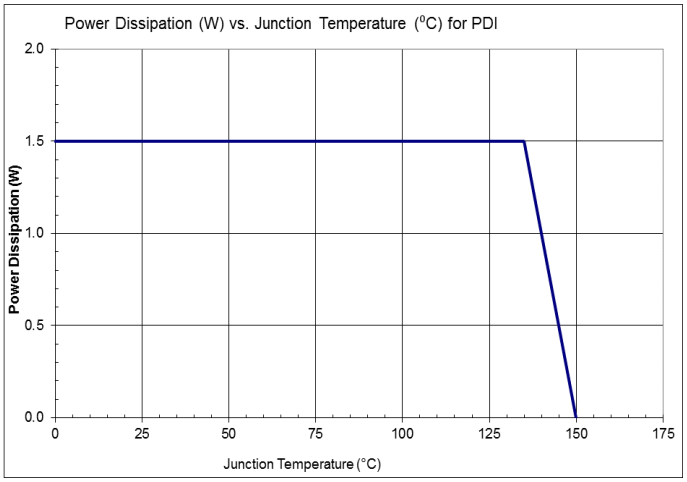


Figure 13 Power Dissipation vs. Junction Temperature

Typical Performance Characteristics (15mA, 20mA, 25mA, 30mA, 40mA, 50mA PowerDI options)

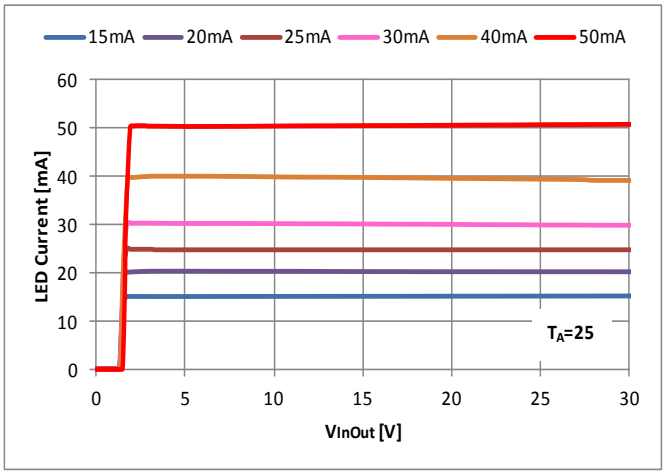


Figure 14 LED Current vs. VInOut

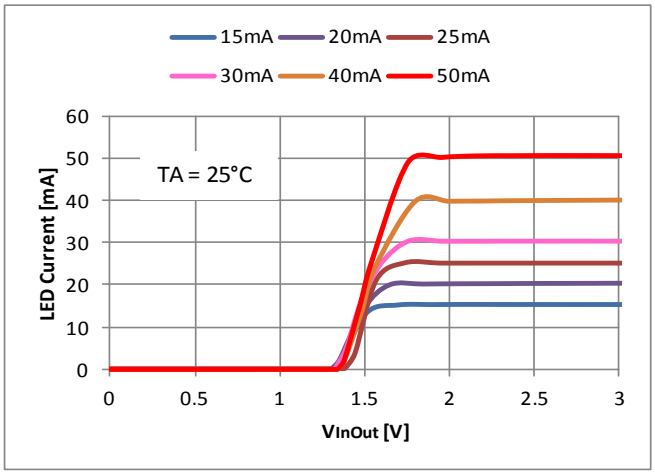


Figure 15 Startup Minimum Operating Voltage

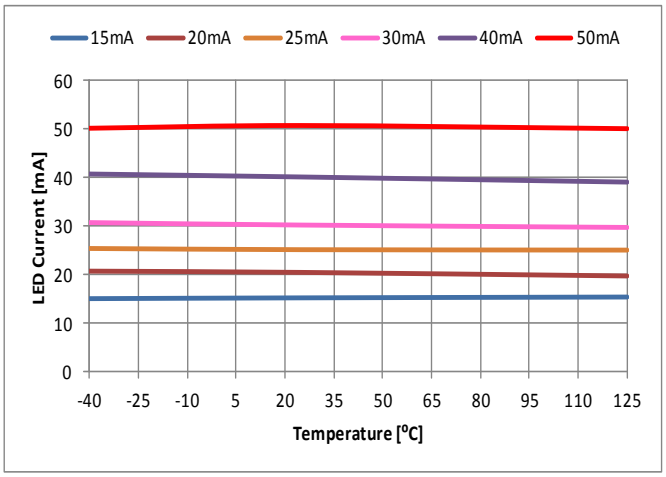


Figure 16 LED Current vs. Ambient Temperature

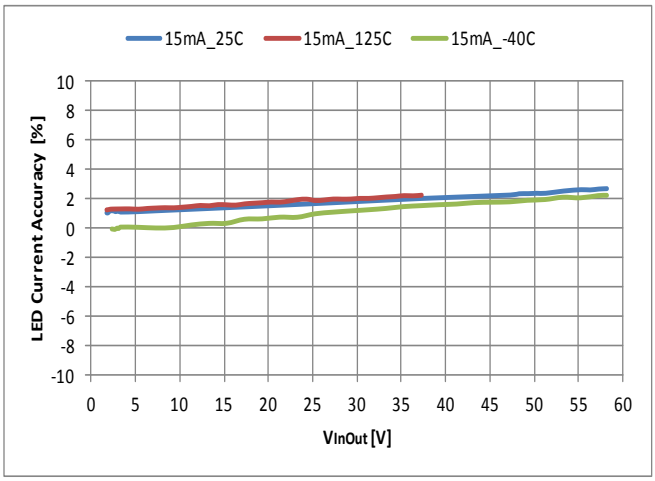


Figure 17 LED Current Accuracy (%) vs. VInOut across Temperature

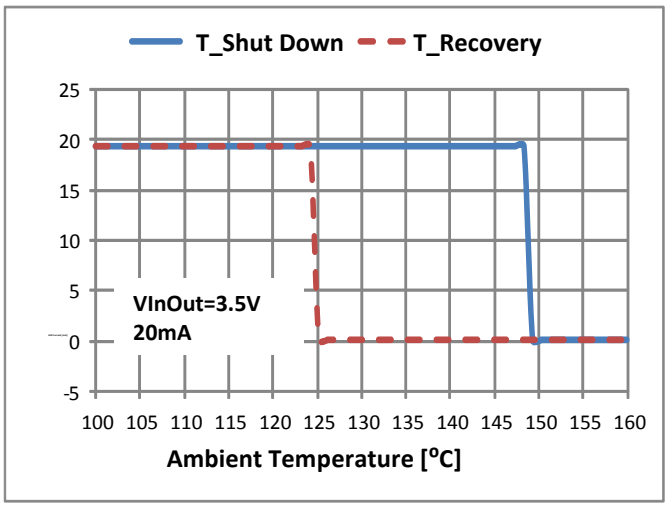


Figure 18 THSD of 20mA Current Option

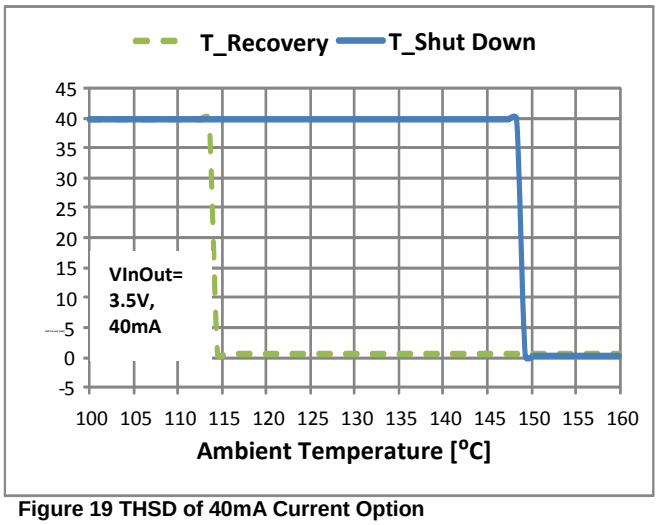


Figure 19 THSD of 40mA Current Option

Typical Performance Characteristics (continued) (60mA, 90mA, 150mA PowerDI options)

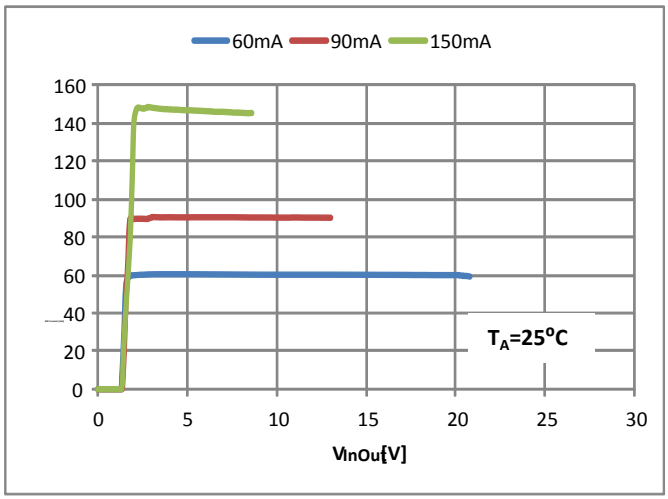


Figure 20 LED Current vs. VInOut

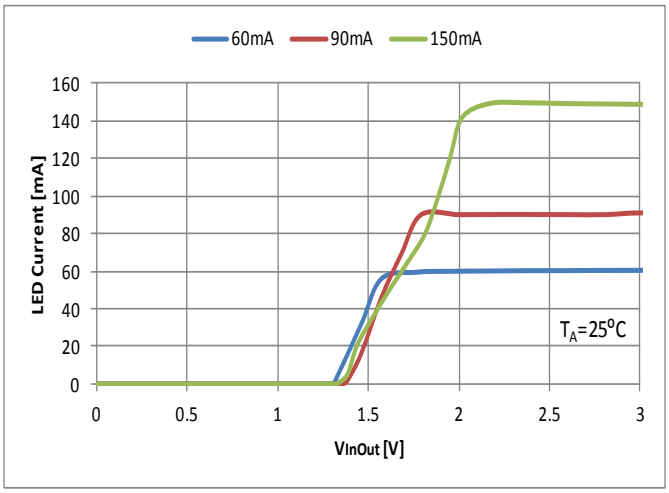


Figure 21 Startup Minimum Operating Voltage

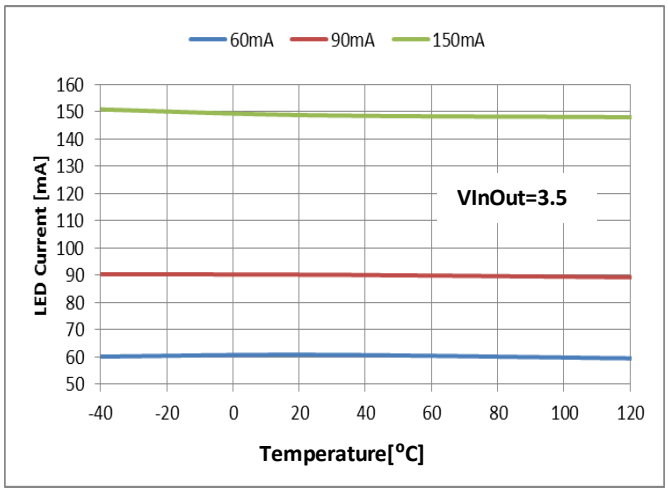


Figure 22 LED Current across Temperature

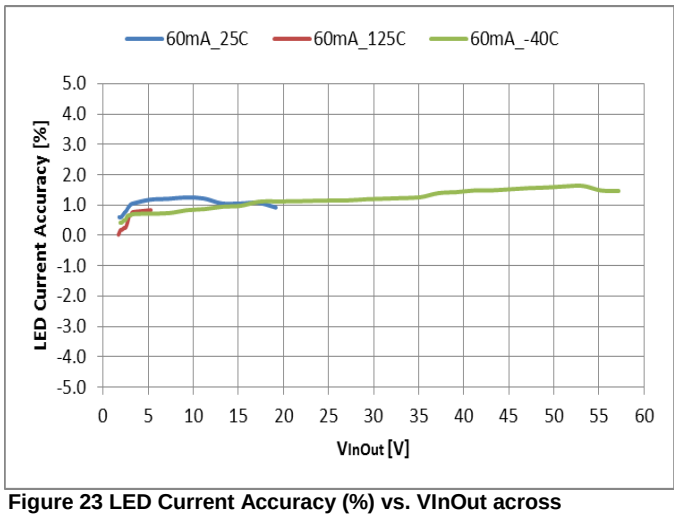


Figure 23 LED Current Accuracy (%) vs. VInOut across Temperature

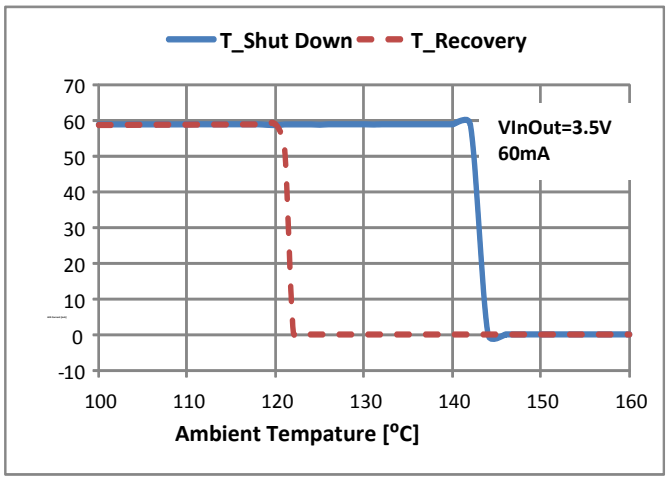


Figure 24 THSD of 60mA Current Option

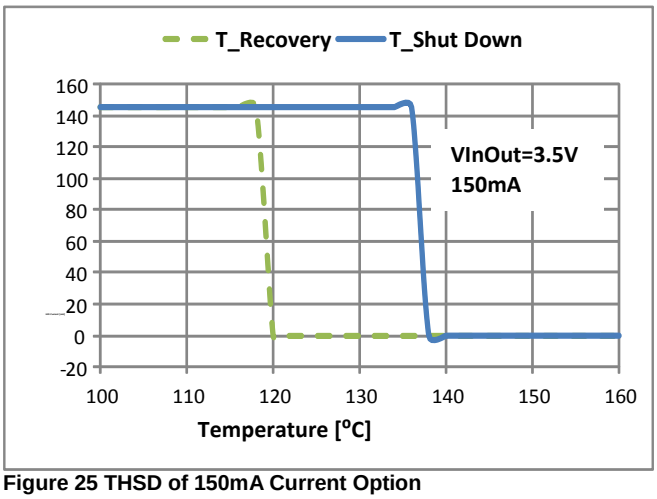
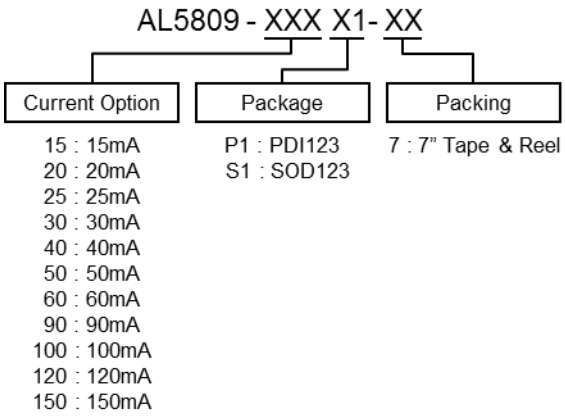


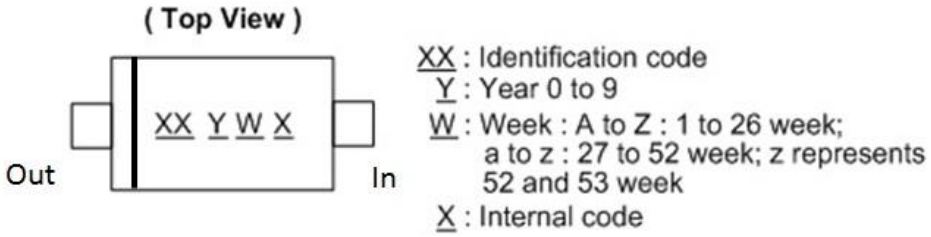
Figure 25 THSD of 150mA Current Option

Ordering Information



Part Number	LED Current Opion	Package Code	Packaging	7" Tape and Reel	
				Quantity	Part Number Suffix
AL5809-15P1-7	15mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-15S1-7		S1	SOD-123	3,000/ Tape & Reel	-7
AL5809-20P1-7	20mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-20S1-7		S1	SOD-123	3,000/ Tape & Reel	-7
AL5809-25P1-7	25mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-25S1-7		S1	SOD-123	3,000/ Tape & Reel	-7
AL5809-30P1-7	30mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-30S1-7		S1	SOD-123	3,000/ Tape & Reel	-7
AL5809-40P1-7	40mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-40S1-7		S1	SOD-123	3,000/ Tape & Reel	-7
AL5809-50P1-7	50mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-50S1-7		S1	SOD-123	3,000/ Tape & Reel	-7
AL5809-60P1-7	60mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-90P1-7	90mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-100P1-7	100mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-120P1-7	120mA	P1	PowerDI123	3,000/ Tape & Reel	-7
AL5809-150P1-7	150mA	P1	PowerDI123	3,000/ Tape & Reel	-7

Marking Information

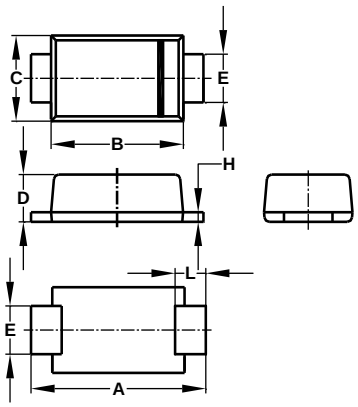


Part Number	Package	Identification Code
AL5809-15P1-7	PowerDI123	C1
AL5809-20P1-7	PowerDI123	C2
AL5809-25P1-7	PowerDI123	CA
AL5809-30P1-7	PowerDI123	C3
AL5809-40P1-7	PowerDI123	C4
AL5809-50P1-7	PowerDI123	C5
AL5809-60P1-7	PowerDI123	C6
AL5809-90P1-7	PowerDI123	C7
AL5809-100P1-7	PowerDI123	CB
AL5809-120P1-7	PowerDI123	C8
AL5809-150P1-7	PowerDI123	C9
AL5809-15S1-7	SOD-123	D1
AL5809-20S1-7	SOD-123	D2
AL5809-25S1-7	SOD-123	DA
AL5809-30S1-7	SOD-123	D3
AL5809-40S1-7	SOD-123	D4
AL5809-50S1-7	SOD-123	D5

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123 (Type B)

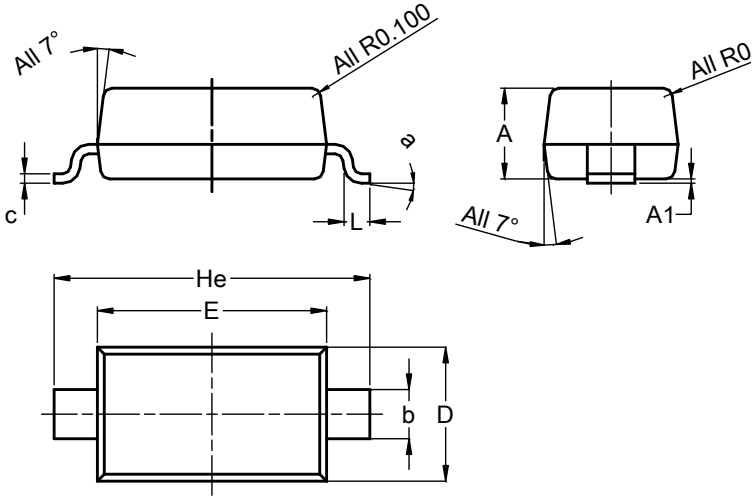


PowerDI123 Type B			
Dim	Min	Max	Typ
A	3.50	3.90	3.70
B	2.60	3.00	2.80
C	1.63	1.93	1.78
D	0.93	1.00	0.98
E	0.85	1.25	1.00
H	0.15	0.25	0.20
L	0.50	0.80	0.65
All Dimensions in mm			

Package Outline Dimensions (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123

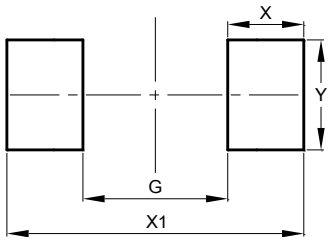


SOD123			
Dim	**Min**	**Max**	**Typ**
A	1.00	1.35	1.05
A1	0.00	0.10	0.05
b	0.52	0.62	0.57
c	0.10	0.15	0.11
D	1.40	1.70	1.55
E	2.55	2.85	2.65
He	3.55	3.85	3.65
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

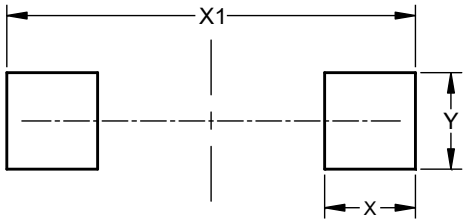
Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123 (Type B)



Dimensions	Value (in mm)
G	2.000
X	1.050
X1	4.100
Y	1.500

SOD123

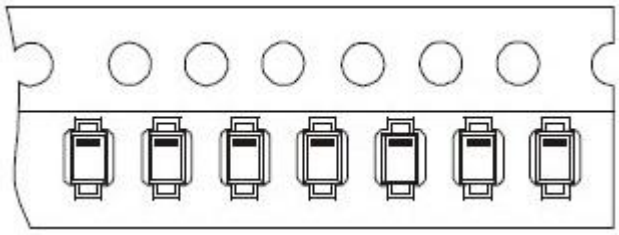


Dimensions	Value (in mm)
X	0.900
X1	4.050
Y	0.950

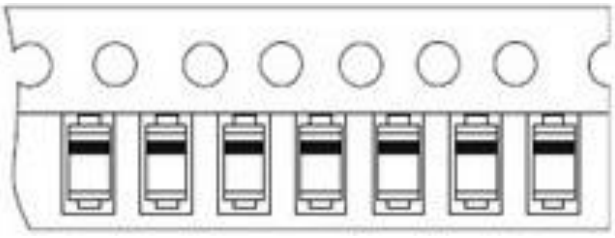
Taping Orientation

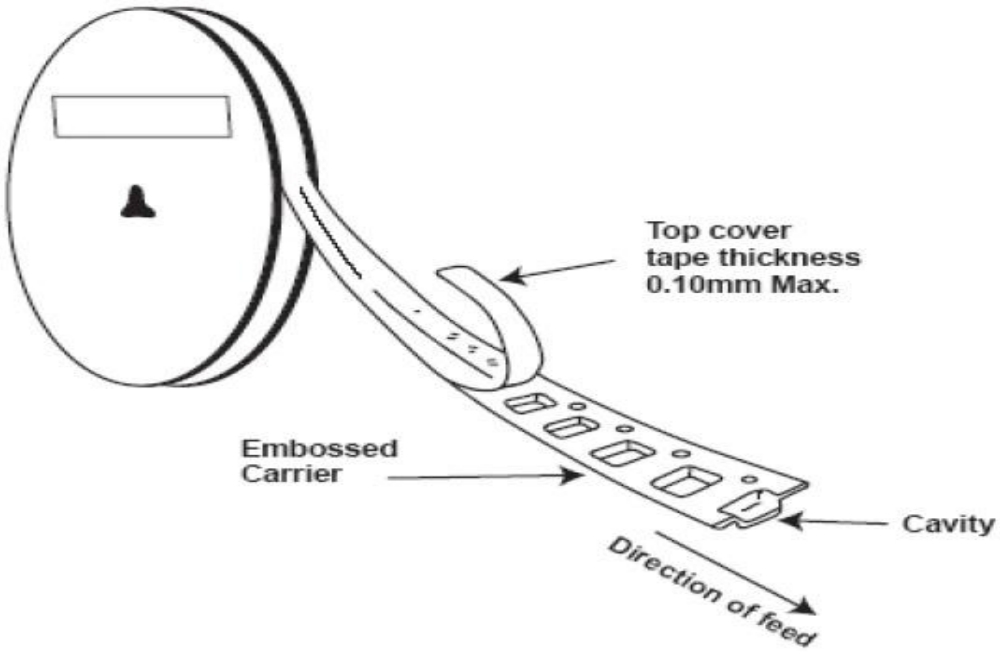
The taping orientation of the other package type can be found on our website at http://www.diodes.com/datasheets/ap02007.pdf.

PowerDI123 (Type B)



SOD123





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